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- Max  $r_{DS(on)}$  = 6.0 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 21 A
- 100% UIL test
- RoHS Compliant

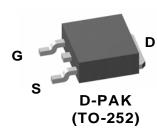


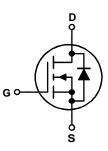
## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$  and fast switching speed.

# Applications

- Vcore DC-DC for Desktop Computers and Servers
- VRM for Intermediate Bus Architecture





## MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		50	A	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		131		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	27		
	-Pulsed			200		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	72	mJ	
	Power Dissipation	T <sub>C</sub> = 25 °C		65	14/	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.7	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature R	ange		-55 to +175	°C	

### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case		2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/W

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD6760A	FDD6760A	D-PAK (TO-252)	13 "	16 mm	2500 units

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March 2015

	FDD6760A N-Channel Power Trench <sup>®</sup> MOSFET
	∍nch <sup>®</sup>
	NOSI
_	FET

Units

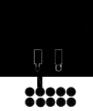
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	25			V
ΔBV <sub>DSS</sub> ΔT,	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		16		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.0	1.6	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 27 A		2.3	3.2	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 21 \text{ A}$		4.4	6.0	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 27 A, T <sub>J</sub> = 150 °C		3.5	4.9	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 27 A		186		S
Dvnamio	c Characteristics					
C <sub>iss</sub>	Input Capacitance			2380	3170	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 13 V, V_{GS} = 0 V,$		525	700	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		470	710	pF
R <sub>q</sub>	Gate Resistance	f = 1MHz		1.3		Ω
*						
	ng Characteristics			10	20	ns
t <sub>d(on)</sub>	Turn-On Delay Time	Vpp = 13 V. lp = 27 A.		10 9	20 18	ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	$V_{DD} = 13$ V, I <sub>D</sub> = 27 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		-	-	-
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time			9	-	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		9 28	-	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		9 28 6	18	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge			9 28 6 44	18 62	ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 13 \text{ V},$		9 28 6 44 25	18 62	ns ns nS nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 13 \text{ V},$		9 28 6 44 25 6	18 62	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sc</b>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         Durce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 13 \text{ V},$ $I_{D} = 17 \text{ A}$		9 28 6 44 25 6	18 62	ns ns nC nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sc</b>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 13 \text{ V},$ $I_D = 17 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 3.1 \text{ A}$ (Note 2)		9 28 6 44 25 6 9.9	18 62 35	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sc</b> V <sub>SD</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         Durce Diode Characteristics	$\begin{array}{c} V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \ \Omega \\ \\ \hline \\ V_{GS} = 0 \text{ V to } 10 \text{ V} \\ \hline \\ V_{GS} = 0 \text{ V to } 5 \text{ V} \\ \hline \\ I_D = 17 \text{ A} \\ \end{array}$		9 28 6 44 25 6 9.9	18 62 35 1.2	ns ns nC nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gg</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         Durce Diode Characteristics         Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 13 \text{ V},$ $I_D = 17 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 3.1 \text{ A}$ (Note 2)		9 28 6 44 25 6 9.9 0.7 0.8	18 62 35 1.2 1.3	ns ns nC nC nC nC

**Test Conditions** 

Min

Тур

Max



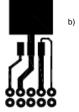
**Electrical Characteristics**  $T_J = 25$  °C unless otherwise noted

Parameter

Symbol

a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

2





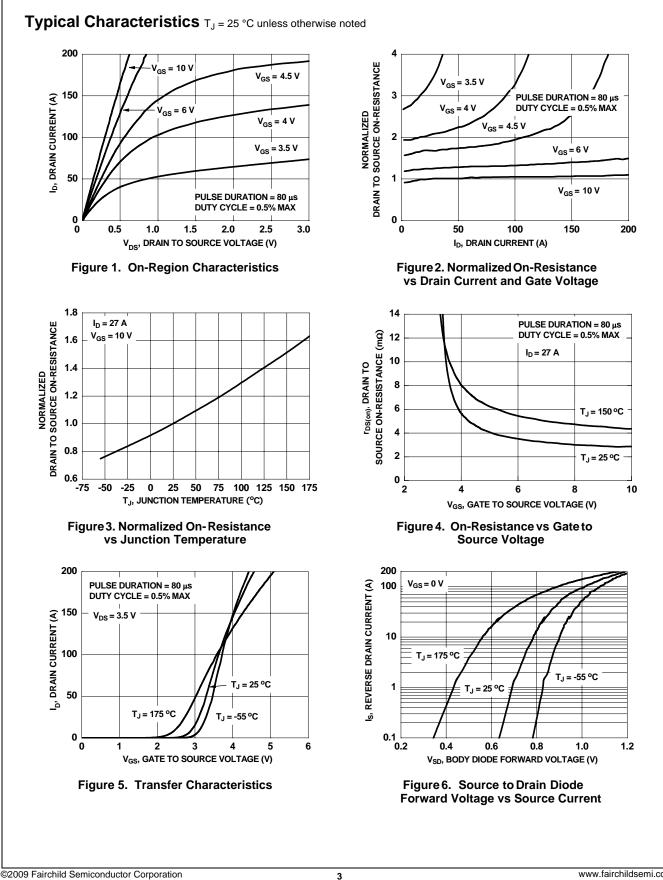
b) 96 °C/W when mounted on a minimum pad.

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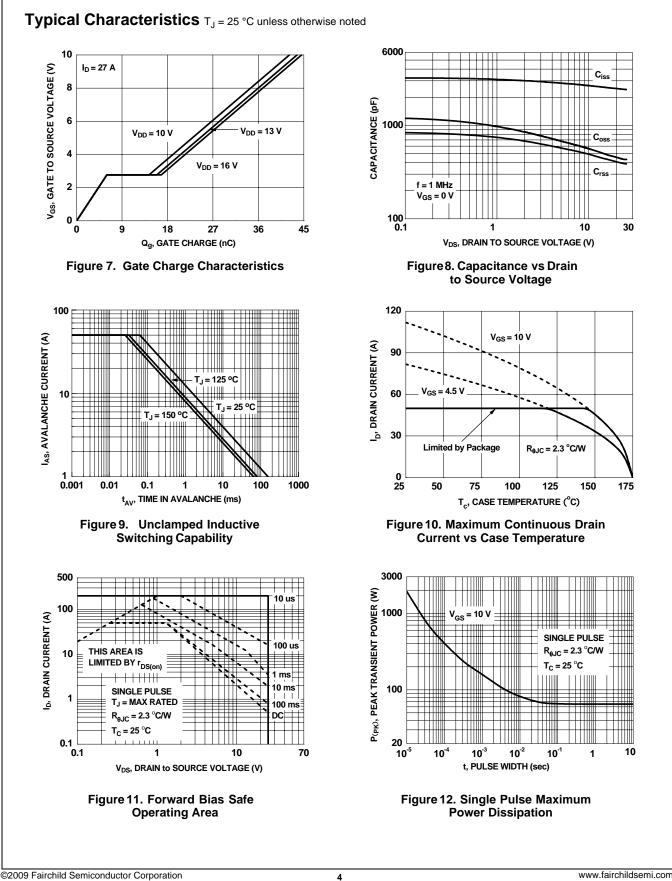
**2:** Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. **3:** E<sub>AS</sub> of 72 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 12 A, V<sub>DD</sub> = 23 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 29 A. ©2009 Fairchild Semiconductor Corporation FDD6760A Rev. 1.2

FDD6760A N-Channel Power Trench<sup>®</sup> MOSFET



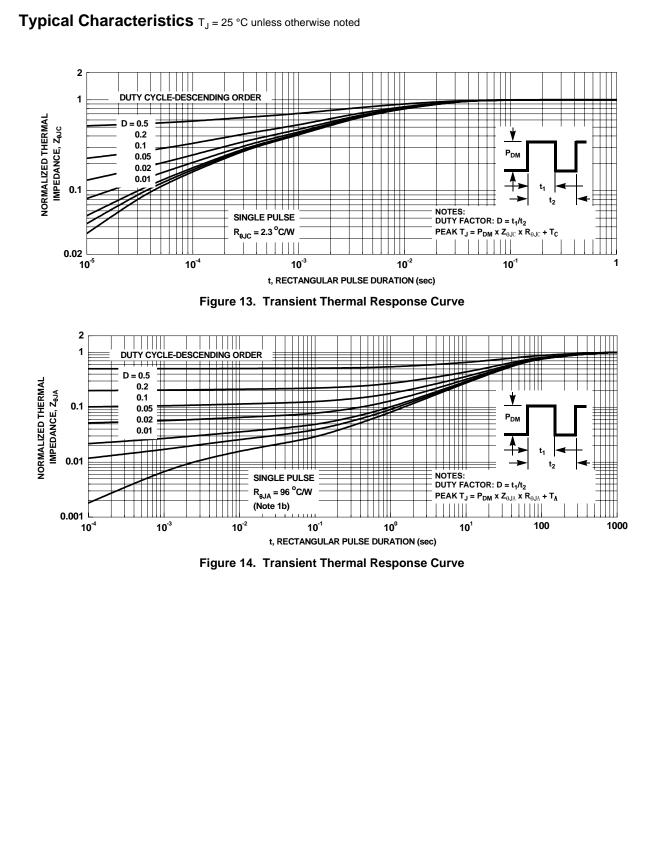
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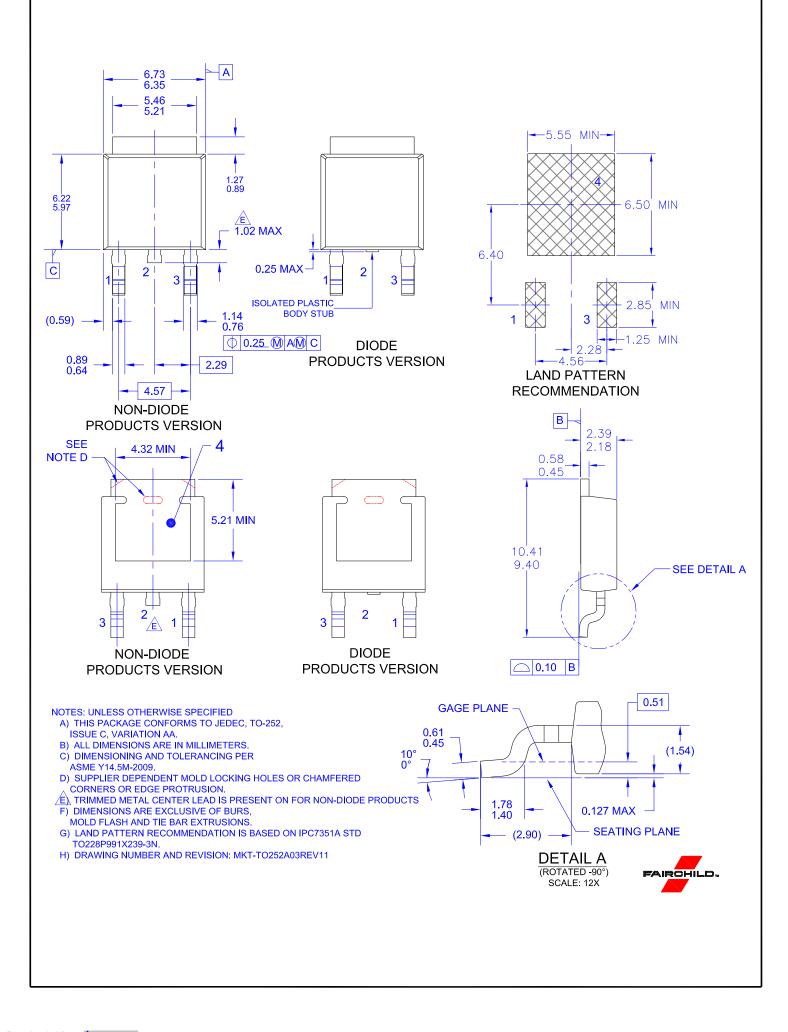
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